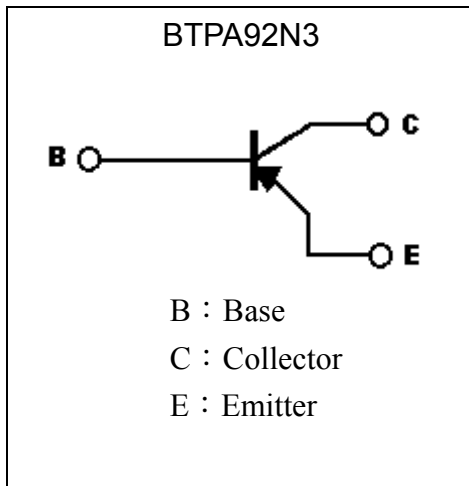
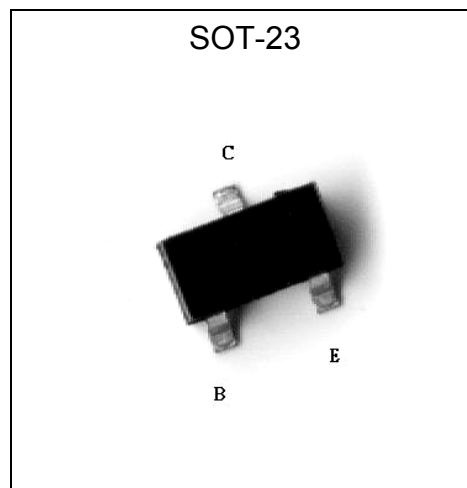


General Purpose PNP Epitaxial Planar Transistor

BTPA92N3

Description

- High breakdown voltage. ($BV_{CEO}=-300V$)
- Low collector output capacitance.
- Ideal for chroma circuit.

Symbol

Outline

Absolute Maximum Ratings ($T_a=25^{\circ}C$)

Parameter	Symbol	Limits	Unit
Collector-Base Voltage	V_{CBO}	-300	V
Collector-Emitter Voltage	V_{CEO}	-300	V
Emitter-Base Voltage	V_{EBO}	-5	V
Collector Current	I_C	-500	mA
Power Dissipation	P_d	225	mW
Thermal Resistance, Junction to Ambient	$R_{\theta JA}$	556	$^{\circ}C/W$
Junction Temperature	T_j	150	$^{\circ}C$
Storage Temperature	T_{stg}	-55~+150	$^{\circ}C$



Characteristics (Ta=25°C)

Symbol	Min.	Typ.	Max.	Unit	Test Conditions
BV _{CBO}	-300	-	-	V	I _C =-100μA
BV _{CEO}	-300	-	-	V	I _C =-1mA
BV _{EBO}	-5	-	-	V	I _E =-100μA
I _{CBO}	-	-	-0.25	μA	V _{CB} =-200V
I _{EBO}	-	-	-0.1	μA	V _{EB} =-3V
*V _{CE(sat)}	-	-	-0.5	V	I _C =-20mA, I _B =-2mA
*V _{BE(sat)}	-	-	-0.9	V	I _C =-20mA, I _B =-2mA
h _{FE 1}	25	-	-	-	V _{CE} =-10V, I _C =-1mA
*h _{FE 2}	56	-	270	-	V _{CE} =-10V, I _C =-10mA
*h _{FE 3}	25	-	-	-	V _{CE} =-10V, I _C =-30mA
f _T	50	-	-	MHz	V _{CE} =-20V, I _C =-10mA, f=100MHz
C _{ob}	-	-	6	pF	V _{CB} =-20V, f=1MHz

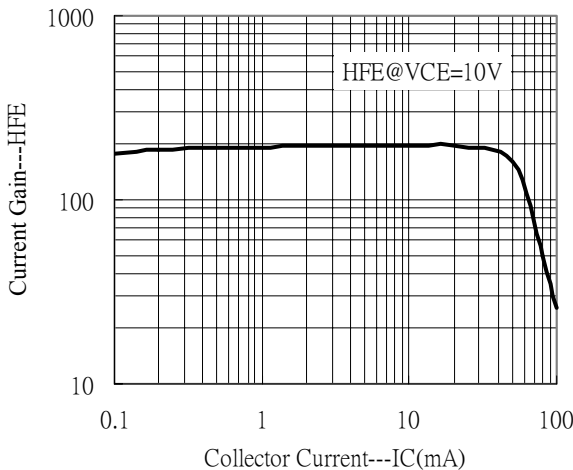
*Pulse Test: Pulse Width ≤380μs, Duty Cycle ≤2%

Classification Of hFE

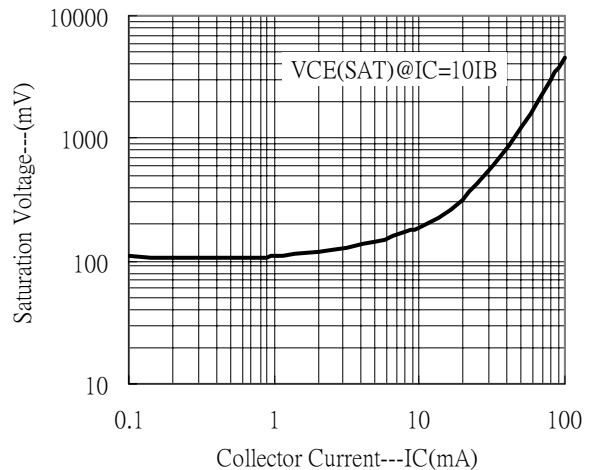
Rank	K	P	Q
Range	56~120	82~180	120~270

Characteristic Curves

Current Gain vs Collector Current

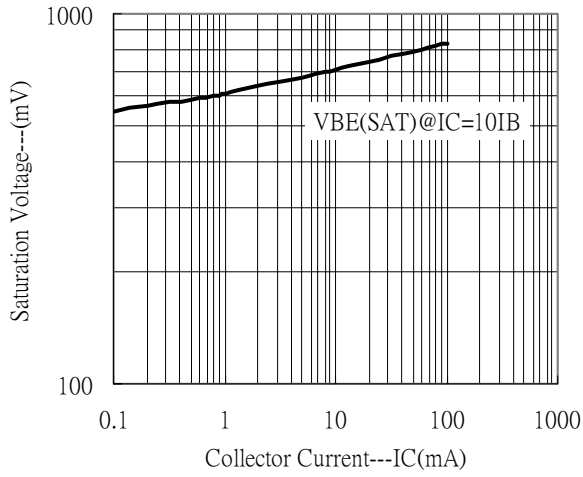


Saturation Voltage vs Collector Current

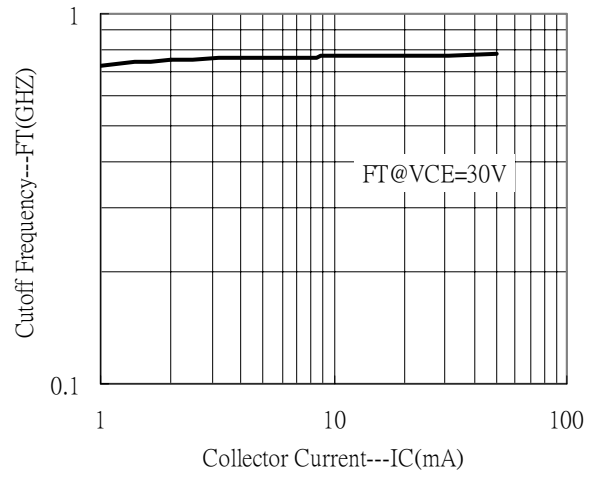




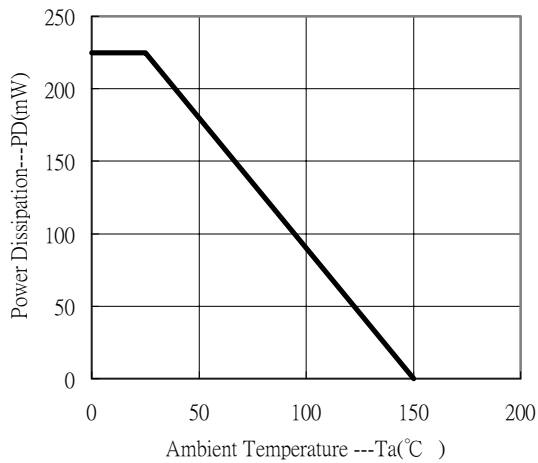
Saturation Voltage vs Collector Current



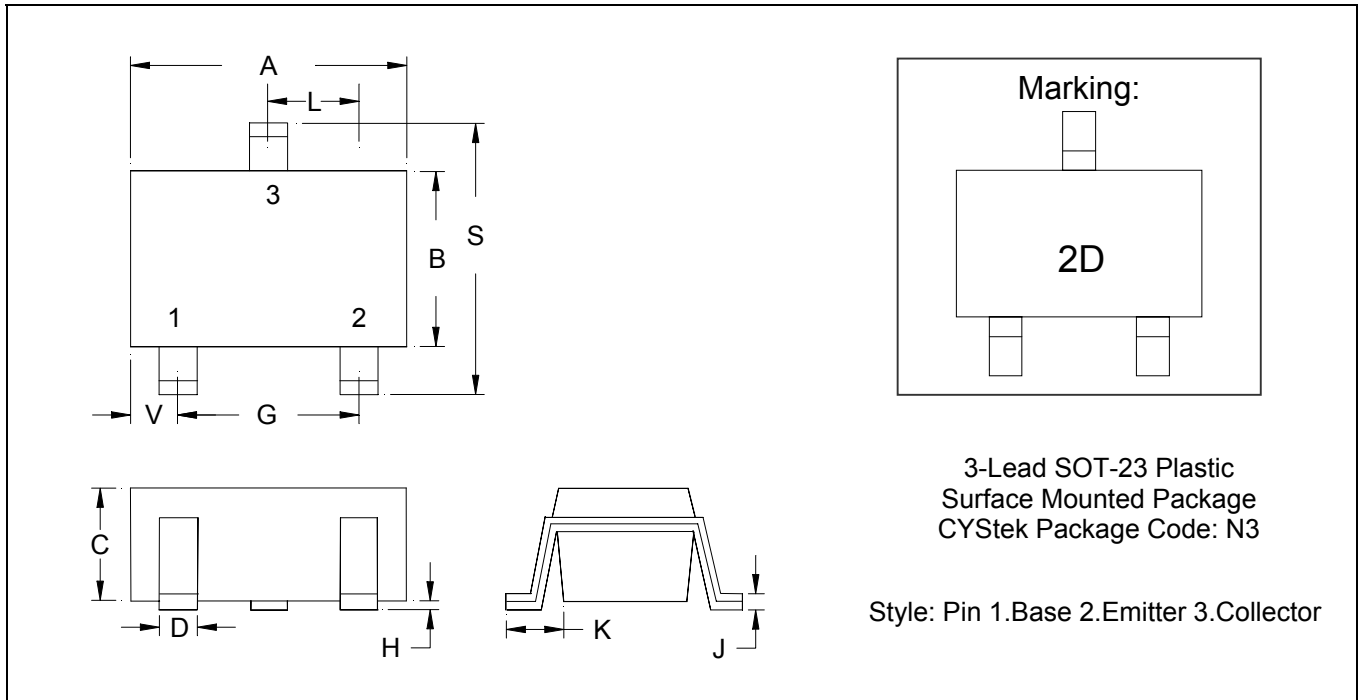
Cutoff Frequency vs Collector Current



Power Derating Curve



SOT-23 Dimension



*: Typical

DIM	Inches		Millimeters		DIM	Inches		Millimeters	
	Min.	Max.	Min.	Max.		Min.	Max.	Min.	Max.
A	0.1102	0.1204	2.80	3.04	J	0.0034	0.0070	0.085	0.177
B	0.0472	0.0630	1.20	1.60	K	0.0128	0.0266	0.32	0.67
C	0.0335	0.0512	0.89	1.30	L	0.0335	0.0453	0.85	1.15
D	0.0118	0.0197	0.30	0.50	S	0.0830	0.1083	2.10	2.75
G	0.0669	0.0910	1.70	2.30	V	0.0098	0.0256	0.25	0.65
H	0.0005	0.0040	0.013	0.10					

- Notes: 1.Controlling dimension: millimeters.
 2.Maximum lead thickness includes lead finish thickness, and minimum lead thickness is the minimum thickness of base material.
 3.If there is any question with packing specification or packing method, please contact your local CYStek sales office.

Material:

- Lead: 42 Alloy ; solder plating
- Mold Compound: Epoxy resin family, flammability solid burning class: UL94V-0

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